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Choi (43) **Pub. Date: Dec. 1, 2005**(54) **LIQUID CRYSTAL DISPLAY AND
MANUFACTURING METHOD THEREOF**(30) **Foreign Application Priority Data**

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MCLEAN, VA 22102 (US)(57) **ABSTRACT**

A liquid crystal display is provided, which includes: a substrate; a color filter formed on the substrate, and having a depression and an opening; a common electrode formed on the color filter, and having a depression; and a black member formed on the common electrode and located at the depressions of the common electrode.

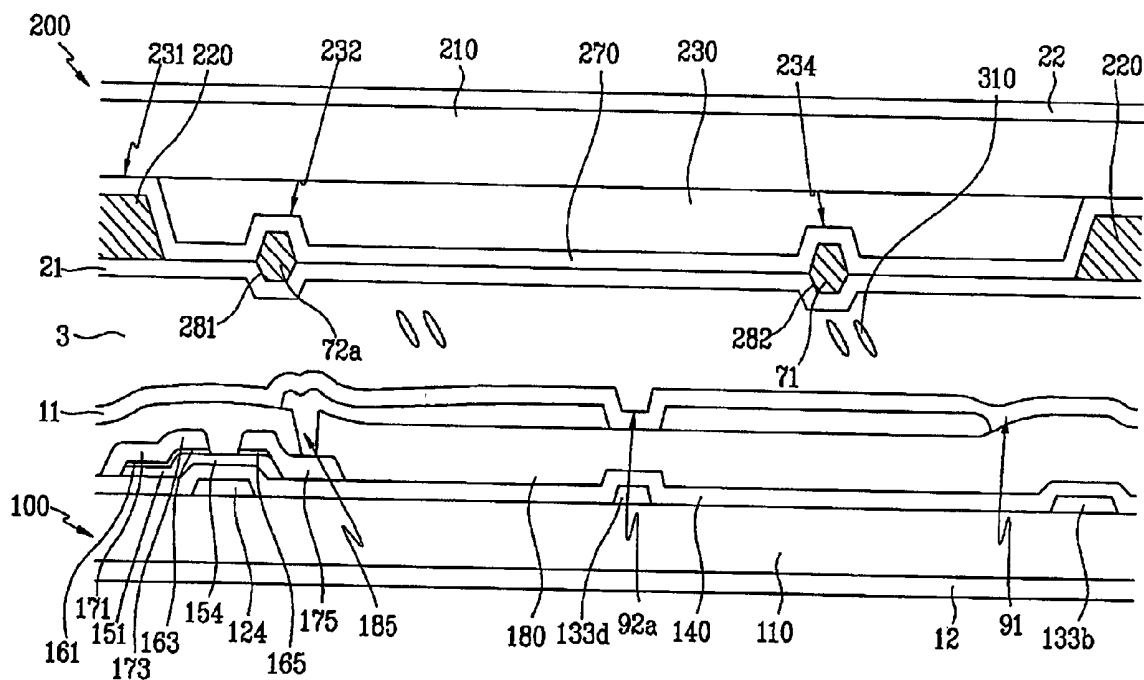
(21) Appl. No.: **11/134,268**(22) Filed: **May 23, 2005**

FIG.1

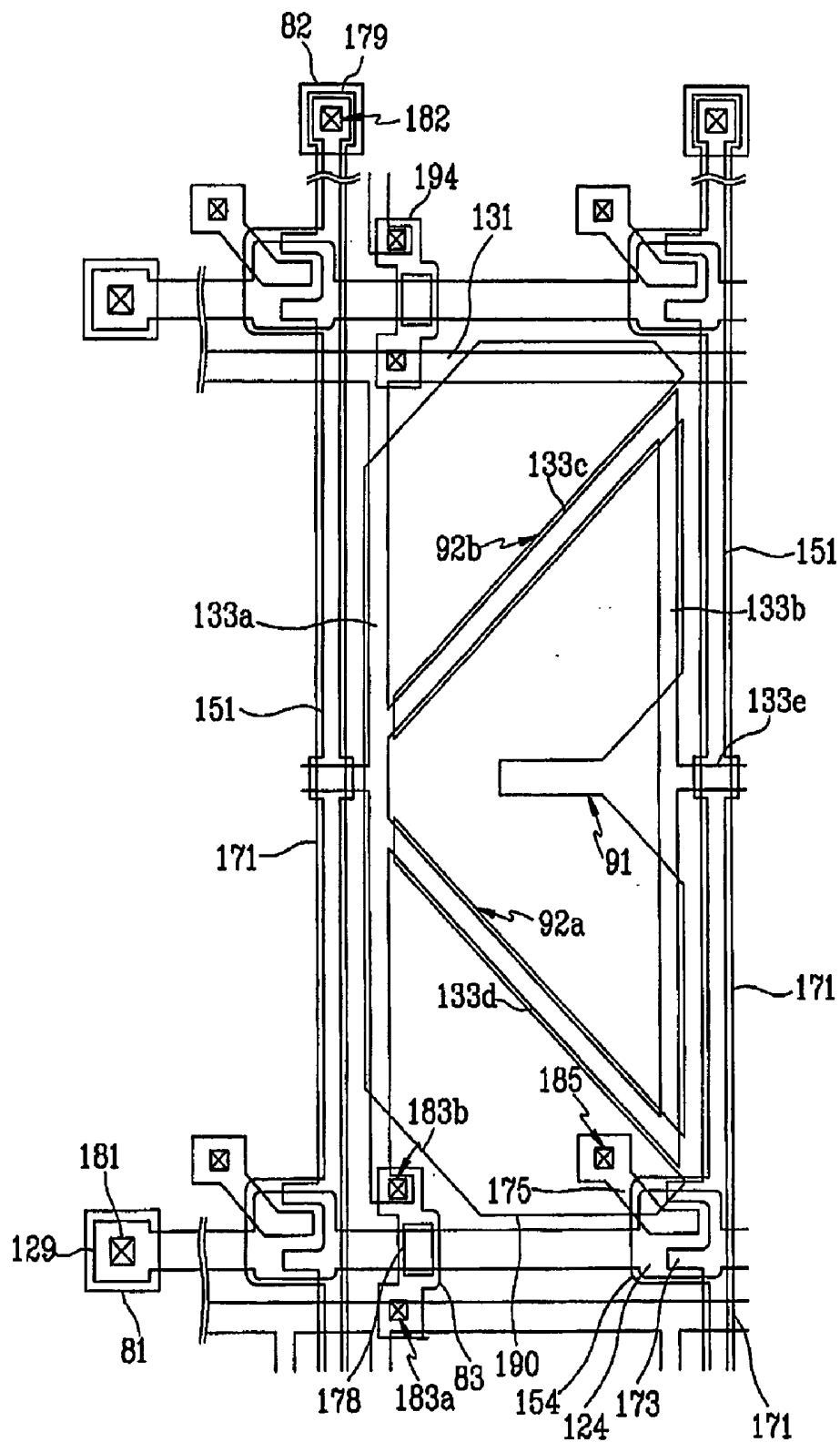


FIG.2

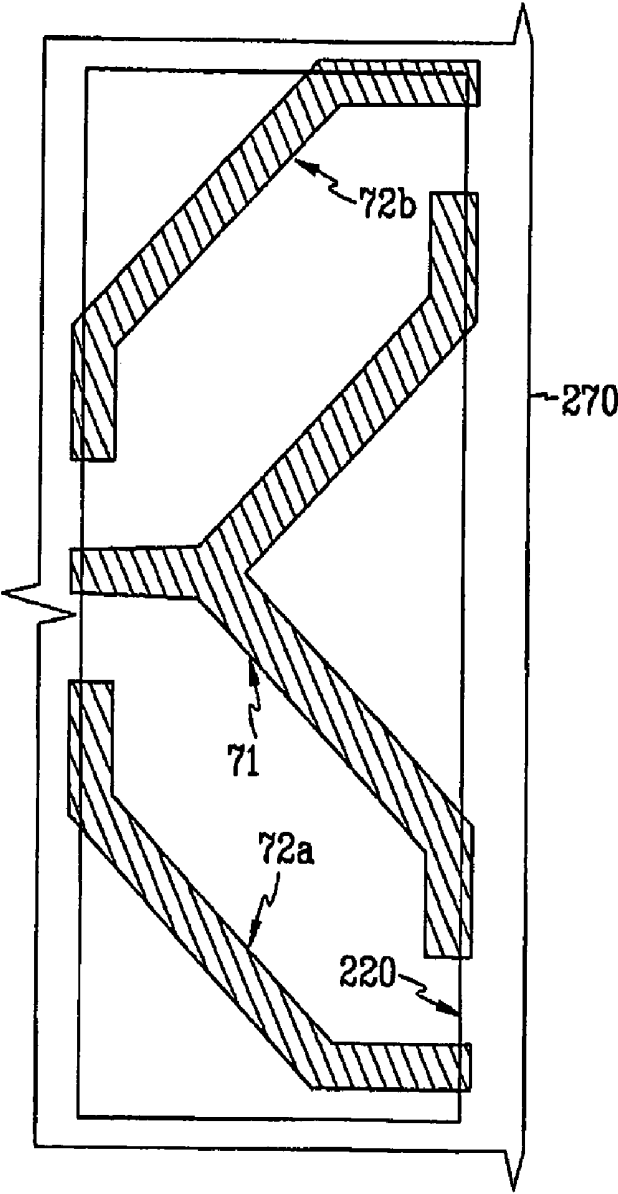


FIG.3

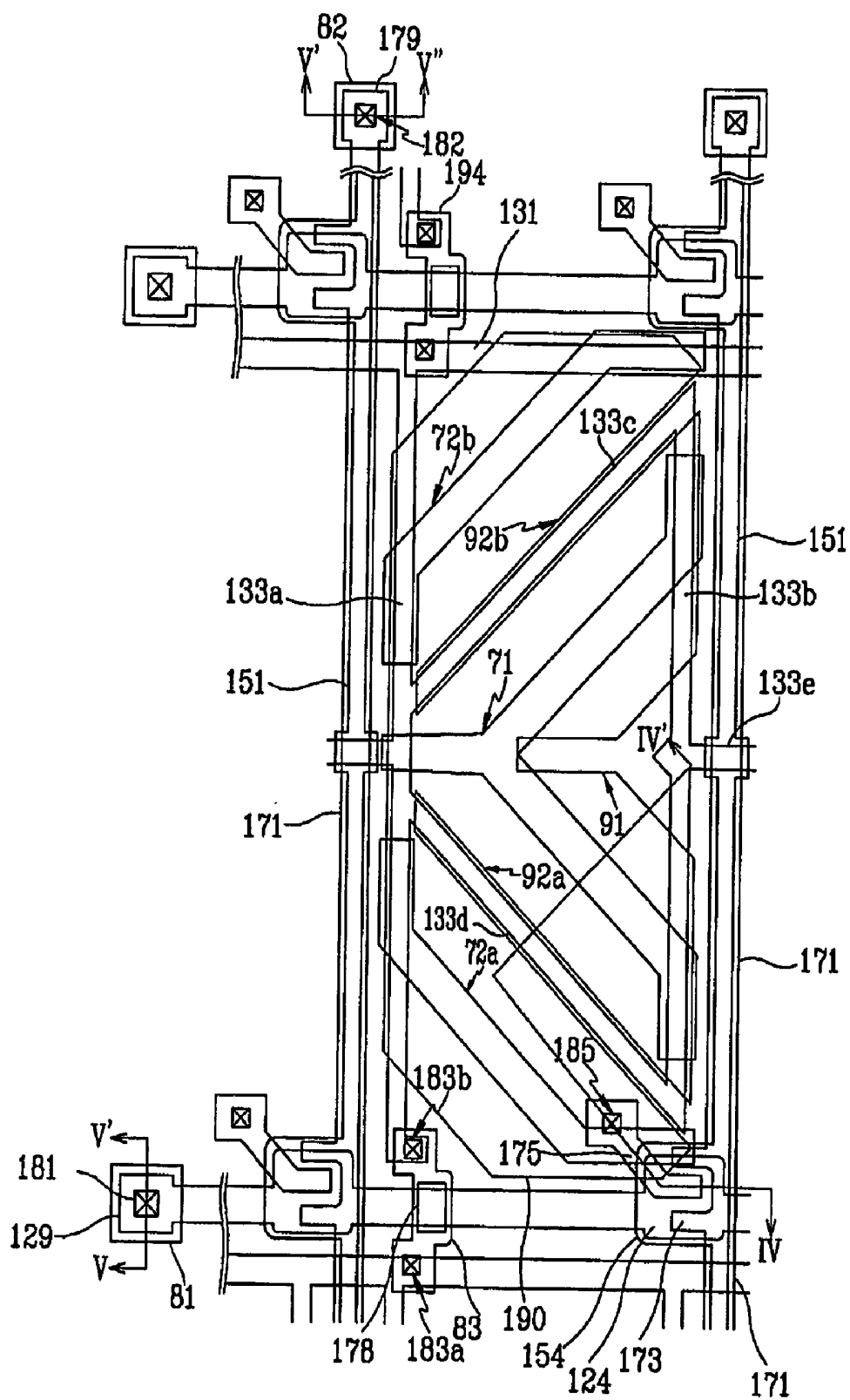


FIG.5

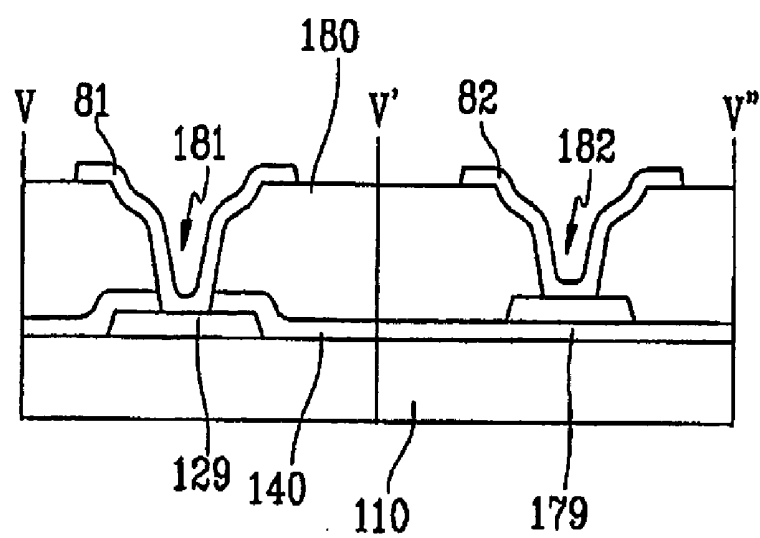


FIG.6A

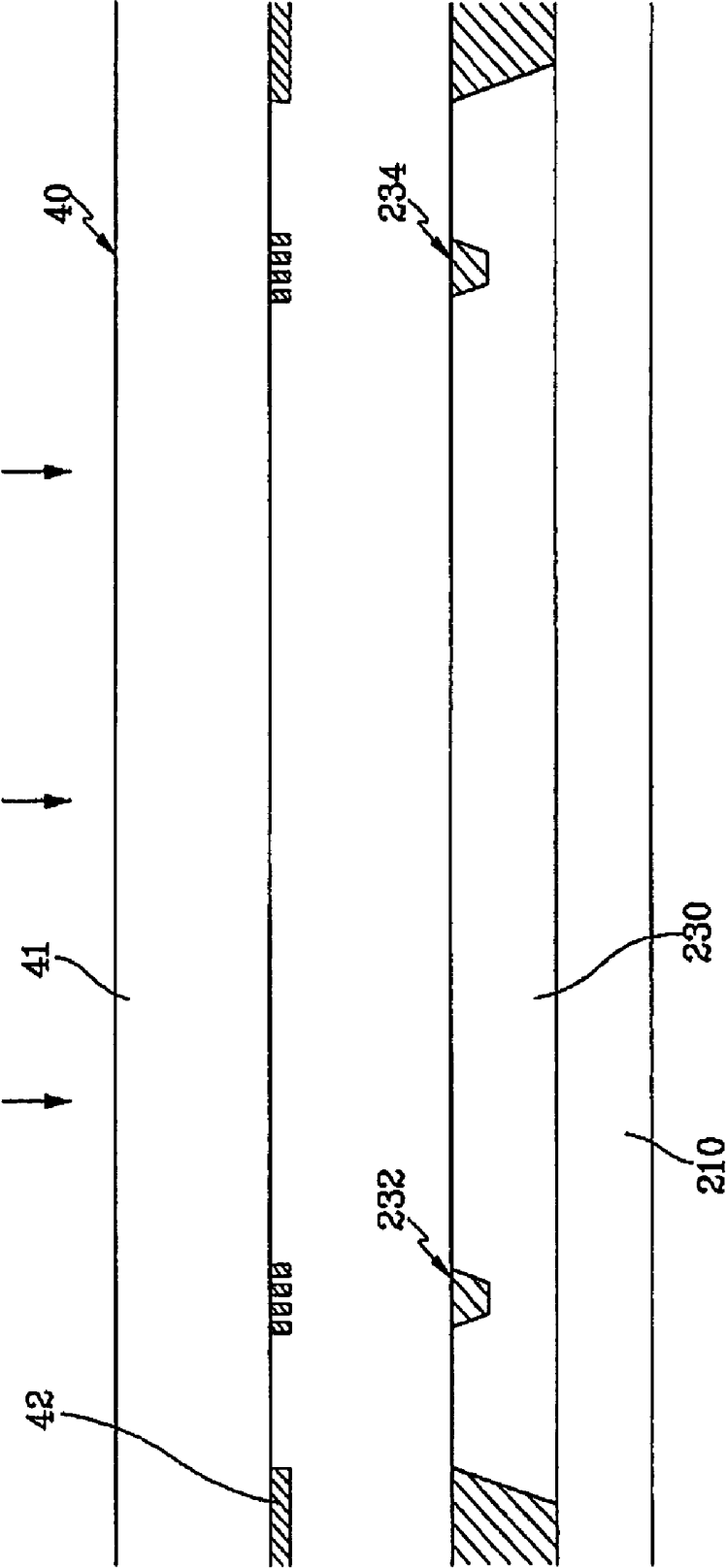


FIG.6B

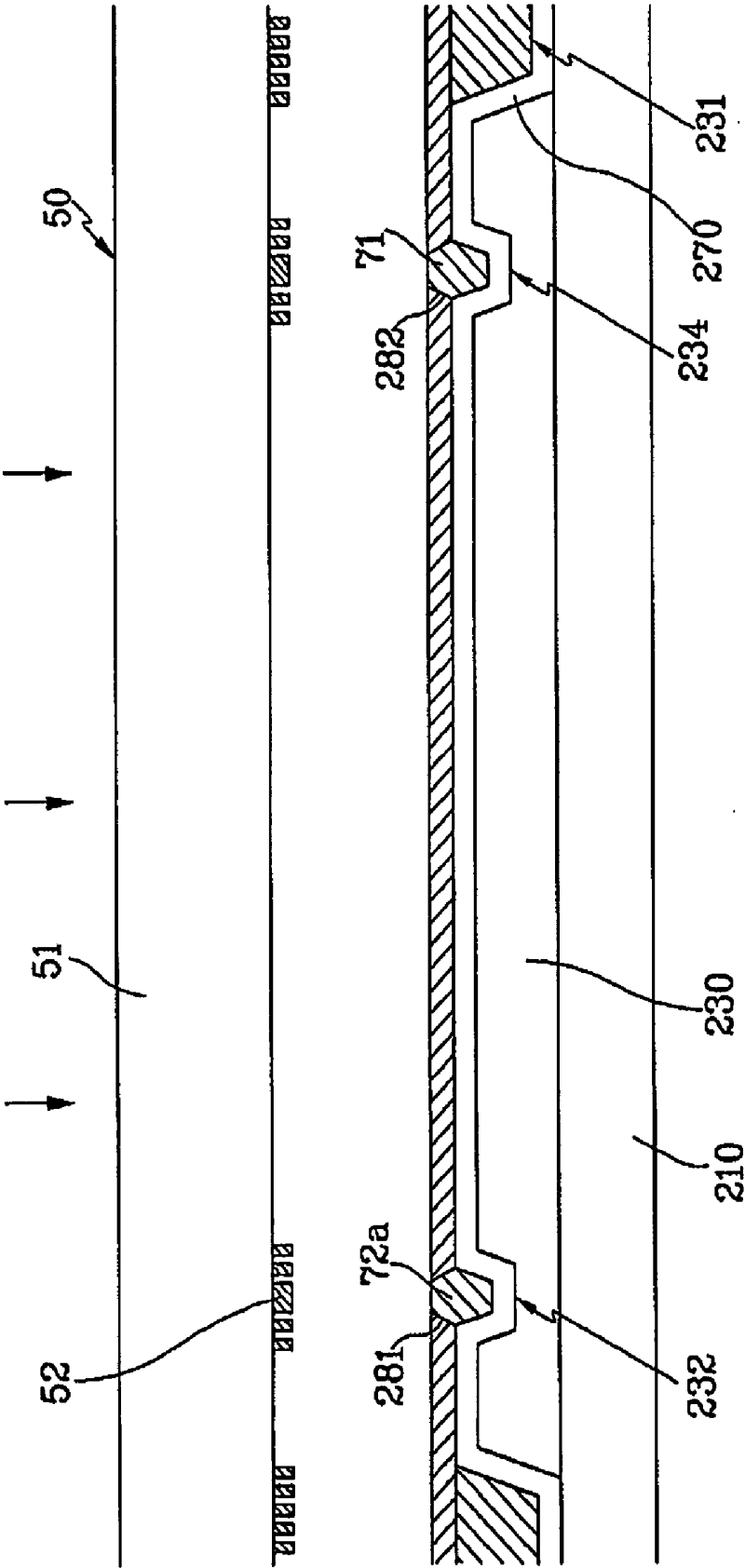


FIG.7A

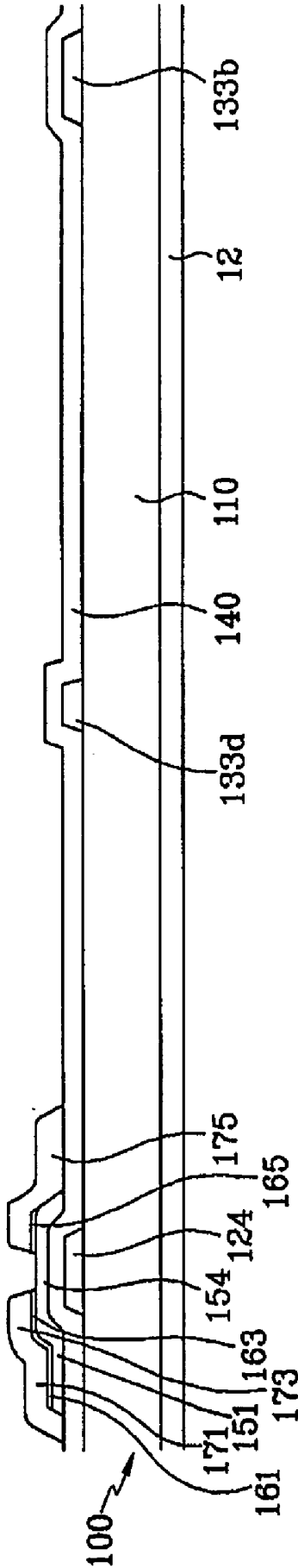


FIG. 7B

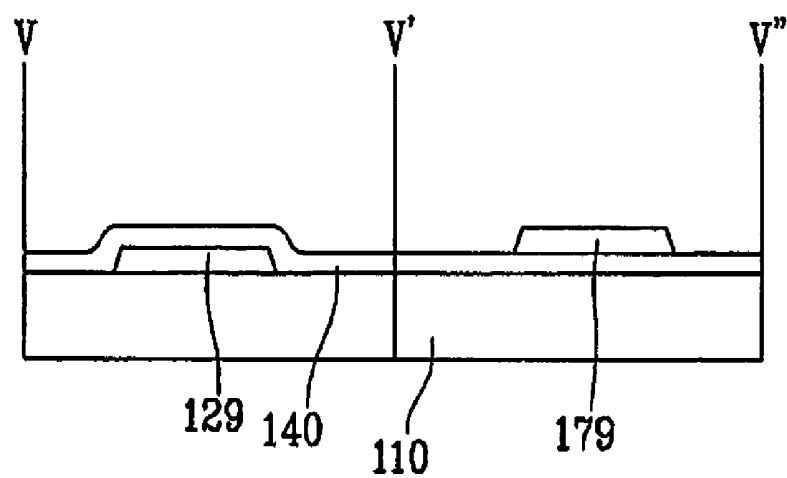
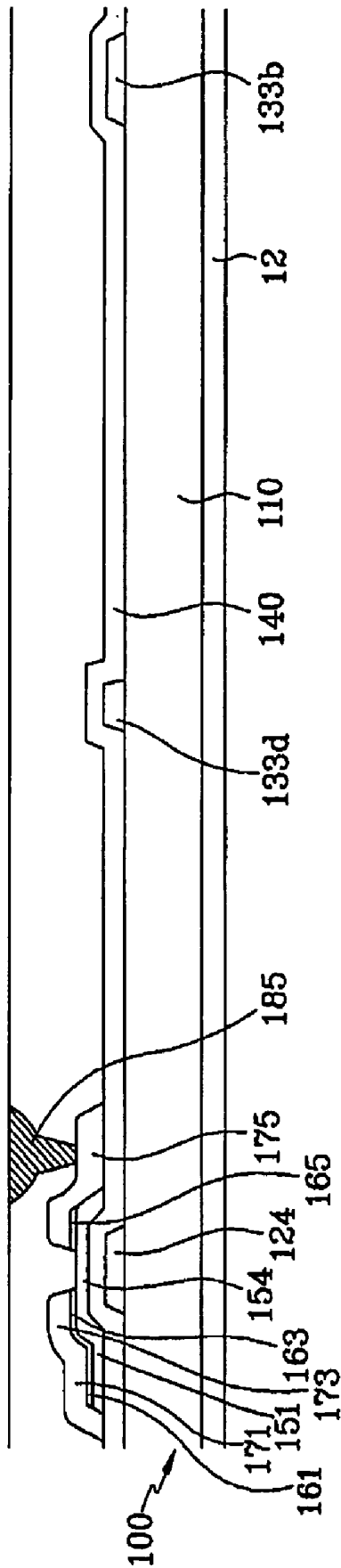
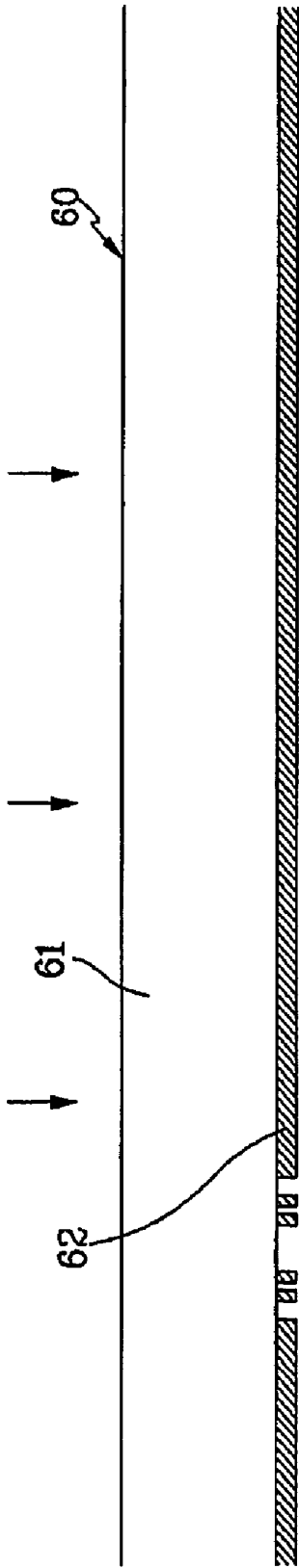


FIG.8A



LIQUID CRYSTAL DISPLAY AND MANUFACTURING METHOD THEREOF

BACKGROUND OF THE INVENTION

[0001] This application claims the priority of Korean Patent Application No. 10-2004-0036784, filed on May 24, 2004, in the Korean Intellectual Property Office, the disclosure of which is incorporated herein in its entirety by reference.

[0002] 1. Field of the Invention

[0003] The present invention relates to a liquid crystal display and a method for manufacturing the same.

[0004] 2. Discussion of the Background

[0005] A liquid crystal display (LCD) is one of the most widely used flat panel displays. An LCD includes two panels provided with field-generating electrodes, such as pixel electrodes and a common electrode, and a liquid crystal (LC) layer interposed therebetween. The LCD displays images by applying voltages to the field-generating electrodes to generate an electric field in the LC layer, which determines orientations of LC molecules in the LC layer to adjust polarization of incident light.

[0006] A vertical alignment (VA) mode LCD, which aligns LC molecules such that the long axes of the LC molecules are perpendicular to the panels in the absence of an electric field, has a high contrast ratio and a wide reference viewing angle, which is defined as a viewing angle.

[0007] The wide viewing angle of the VA mode LCD can be realized by cutouts in the field-generating electrodes and protrusions on the field-generating electrodes. Since the cutouts and the protrusions can determine the tilt directions of the LC molecules, the tilt directions may be distributed into several directions by using the cutouts and the protrusions such that the reference viewing angle is widened.

[0008] However, because an etchant is used when etching the common electrode to form cutouts in manufacturing method of this LCD, the etchant may penetrate into a color filter in manufacturing process. The penetrated etchant damages and contaminates the color filter. To prevent these problems, a passivation layer may cover the color filter before depositing the common electrode, therefore the manufacturing process becomes complicated. In addition, adding the protrusions on the field-generating electrodes adds operations to the manufacturing process.

SUMMARY OF THE INVENTION

[0009] An object of the invention is to simplify manufacturing methods of liquid crystal display including multi domains. Another object of the invention is to improve response time of liquid crystal display including multi domains.

[0010] The present invention discloses a crystal display, including a substrate, a color filter having a depression and an opening and formed on the substrate, a common electrode having a depression and formed on the color filter, and a light blocking member formed on the common electrode and located at the depression of the common electrode.

[0011] The present invention discloses a liquid crystal display, including a first substrate, a plurality of pixel electrodes, provided on the first substrate, including an opening, a second substrate facing the first substrate, a color filter, provided on the second substrate, having a depression facing the pixel electrodes and an opening facing the region between the pixel electrodes, a common electrode, provided on the color filter, having a depression formed by the depression and the opening of the color filter, and a light blocking member provided on the common electrode and located at the depression of the common electrode.

[0012] The present invention discloses method for manufacturing a liquid crystal display panel, including forming a color filter having a depression and an opening, forming a common electrode on the color filter, and forming a light blocking member on the common electrode, wherein, the light blocking member is formed by a photolithography process using a photo-mask having an opaque area facing the depression of the color filter, a translucent area facing the opening of the color filter, and a transmissive area facing a portion of the color filter that does not include the depression or the opening.

[0013] The present invention discloses a liquid crystal display, including a substrate, a color filter, provided on the substrate, having a depression and an opening, a common electrode, provided on the color filter, having a depression formed by the depression and the opening of the color filter, and a black matrix formed on the common electrode.

[0014] It is to be understood that both the foregoing general description and the following is detailed description are exemplary and explanatory and are intended to provide further explanation of the invention as claimed.

BRIEF DESCRIPTION OF THE DRAWINGS

[0015] The accompanying drawings, which are included to provide a further understanding of the invention and are incorporated in and constitute a part of this specification, illustrate embodiments of the invention and together with the description serve to explain the principles of the invention.

[0016] FIG. 1 is a layout view of a TFT array panel of an LCD according to an embodiment of the invention.

[0017] FIG. 2 is a layout view of a common electrode panel of an LCD according to an embodiment of the invention.

[0018] FIG. 3 is a layout view of an LCD including the TFT array panel shown in FIG. 1 and the common electrode panel shown in FIG. 2.

[0019] FIG. 4 is a sectional view of the LCD shown in FIG. 3 taken along the line IV-IV'.

[0020] FIG. 5 is a sectional view of the LCD shown in FIG. 3 taken along the lines V-V' and V'-V''.

[0021] FIG. 6A and FIG. 6B are sectional views of the common electrode panel shown in FIG. 2, FIG. 3, and FIG. 4 in intermediate steps of a manufacturing method thereof according to an embodiment of the invention.

[0022] FIG. 7A and FIG. 7B are sectional views of the TFT array panel shown in FIG. 1, FIG. 3, FIG. 4, and FIG.

5 in an intermediate step of a manufacturing method thereof according to an embodiment of the invention.

[0023] FIG. 8A and FIG. 8B are sectional views of the TFT array panel, respectively, showing the TFT array panel after the manufacturing method is performed following the TFT array panel shown in FIG. 7A and FIG. 7B.

DETAILED DESCRIPTION OF THE ILLUSTRATED EMBODIMENTS

[0024] The present invention now is described more fully hereinafter with reference to the accompanying drawings, in which preferred embodiments of the invention are shown. The present invention may, however, be embodied in many different forms and should not be construed as limited to the embodiments set forth herein.

[0025] In the drawings, the thickness of layers, films and regions are exaggerated for clarity. Like numerals refer to like elements throughout. It will be understood that when an element such as a layer, film, region or substrate is referred to as being "on" another element, it can be directly on the other element or intervening elements may also be present. In contrast, when an element is referred to as being "directly on" another element, there are no intervening elements present.

[0026] Liquid crystal displays according to embodiments of the invention are described below with reference to the accompanying drawings. An LCD is described with reference to FIG. 1, FIG. 2, FIG. 3, FIG. 4, and FIG. 5.

[0027] FIG. 1 is a layout view of a TFT array panel of an LCD, FIG. 2 is a layout view of a common electrode panel of an LCD, FIG. 3 is a layout view of an LCD including the TFT array panel shown in FIG. 1 and the common electrode panel shown in FIG. 2, and FIG. 4 and FIG. 5 are sectional views of the LCD shown in FIG. 3 taken along the lines IV-IV', V-V'-V'', respectively.

[0028] Referring to FIG. 1, FIG. 2, FIG. 3, FIG. 4, and FIG. 5, an LCD includes a TFT array panel 100, a common electrode panel 200, and a LC layer 3 interposed between the TFT array panel 100 and the common electrode panel 200. The TFT array panel 100 is described with reference FIG. 1, FIG. 3, and FIG. 4.

[0029] A plurality of gate lines 121 and a plurality of storage electrode lines 131 are formed on an insulating substrate 110, such as transparent glass.

[0030] The gate lines 121 extend substantially in a transverse direction and are separated or spaced apart from each other and transmit gate signals. Each gate line 121 includes a plurality of projections forming a plurality of gate electrodes 124 and an end portion 129 having a large area for contact with another layer or an external driving circuit. The gate lines 121 may extend to be connected with a driving circuit that may be integrated or provided on the TFT array panel 100.

[0031] Each storage electrode line 131 extends substantially in the transverse direction and is disposed between two of the gate lines 121 such that the storage electrode line 131 is positioned nearer to an upper one of the two gate lines 121, as shown, for example, in FIG. 1 and FIG. 3. Each storage electrode line 131 includes a plurality of sets of

branches 133a, 133b, 133c, and 133d and a plurality of connections 133e connecting the branches 133a, 133b, 133c, and 133d.

[0032] A set of branches 133a, 133b, 133c, and 133d includes two longitudinal branches forming first and second storage electrodes 133a and 133b and spaced apart from each other and two oblique branches forming third and fourth storage electrodes 133c and 133d and connected between the first and the second storage electrodes 133a and 133b. In detail, the first storage electrode 133a has a free end portion and a fixed end portion that is connected with the storage electrode line 131 and has a projection. The third and the fourth storage electrodes 133c and 133d extend approximately from a center of the first storage electrode 133a and upper and lower ends of the second storage electrode 133b, respectively.

[0033] Each of the connections 133e is connected between a first storage electrode 133a of a set of storage electrodes 133a, 133b, 133c, and 133d and a second storage electrode 133b of another set of storage electrodes 133a-133d adjacent thereto. It is understood that the invention is not limited to the above-described layout of the storage electrodes 133a, 133b, 133c, and 133d.

[0034] The storage electrode lines 131 are supplied with a predetermined voltage, such as a common voltage, which is applied to a common electrode 270 on the common electrode panel 200 of the LCD. Each storage electrode line 131 may include a pair of stems extending in the transverse direction.

[0035] The gate lines 121 and the storage electrode lines 131 are preferably made of Al containing metal such as Al and Al alloy, Ag containing metal such as Ag and Ag alloy, Cu containing metal such as Cu and Cu alloy, Mo containing metal such as Mo and Mo alloy, Cr, Ti or Ta. The gate lines 121 and the storage electrode lines 131 may be formed of a multi-layered structure including two films having different physical characteristics. One of the two films may be made of low resistivity metal including Al containing metal, Ag containing metal, and Cu containing metal for reducing signal delay or voltage drop in the gate lines 121 and the storage electrode lines 131. The other film may be made of material such as Mo containing metal, Cr, Ta or Ti, which has good physical, chemical, and electrical contact characteristics with materials such as indium tin oxide (ITO) or indium zinc oxide (IZO). According to an embodiment of the invention, a lower film contains Cr and an upper film contains Al—Nd alloy.

[0036] In addition, the lateral sides of the gate lines 121 and the storage electrode lines 131 are inclined relative to a surface of the substrate, and the inclination angle thereof ranges from approximately 30 to 80 degrees.

[0037] A gate insulating layer 140, which may be made of silicon nitride (SiNx), is formed on the gate lines 121 and the storage electrode lines 131.

[0038] A plurality of semiconductor stripes 151, which may be made of hydrogenated amorphous silicon (abbreviated to "a-Si") or polysilicon, are formed on the gate insulating layer 140. Each semiconductor stripe 151 extends substantially in the longitudinal direction and has a plurality of projections 154 branched out toward the gate electrodes 124. The semiconductor stripes 151 are sufficiently wide

near the gate lines 121 and the storage electrode lines 131 such that the semiconductor stripes 151 cover large areas of the gate lines 121 and the storage electrode lines 131.

[0039] A plurality of ohmic contact stripes 161 and ohmic contact islands 165, which may be made of silicide or n+ hydrogenated a-Si heavily doped with n type impurity such as phosphorus, are formed on the semiconductor stripes 151. Each ohmic contact stripe 161 has a plurality of projections 163, and the projections 163 and the ohmic contact islands 165 are located in pairs on the projections 154 of the semiconductor stripes 151.

[0040] The lateral sides of the semiconductor stripes 151 and the ohmic contact stripes 161 and ohmic contact islands 165 are inclined relative to a surface of the substrate, and the inclination angles thereof range between approximately 30 to 80 degrees.

[0041] A plurality of data lines 171, a plurality of drain electrodes 175 that are separate from the data lines 171, and a plurality of isolated metal pieces 178 are formed on the ohmic contact stripes 161, ohmic contact islands 165, and the gate insulating layer 140.

[0042] The data lines 171 for transmitting data voltages extend substantially in the longitudinal direction and cross the gate lines 121 substantially at right angles. The data lines 171 intersect the storage electrode lines 131 and the connections 133e such that each data line 171 is disposed between the first and the second storage electrodes 133a and 133b of adjacent sets of the branches 133a-133d of the storage electrode lines 131. Each data line 171 includes an end portion 179 having a large area for contact with another layer or an external device. Each data line 171 includes a plurality of source electrodes 173 projecting toward the drain electrodes 175.

[0043] Each drain electrode 175 includes an end portion having a portion sufficiently large for contact with another layer and another end portion disposed on a gate electrode 124 and partly enclosed by a source electrode 173. The gate electrode 124, source electrode 173, drain electrode 175, and projection 154 of the semiconductor stripe 151, form a TFT having a channel provided at a region where the projection 154 is disposed between the source electrode 173 and the drain electrode 175.

[0044] The isolated metal pieces 178 are disposed on the gate lines 121 near the end portions of the storage electrodes 133a.

[0045] The data lines 171, the drain electrodes 175, and the metal pieces 178 are may be made of refractory metal such as Cr, Mo, Ti, Ta, or alloys thereof. Further, the data lines 171, the drain electrodes 175, and the metal pieces 178 may have a multilayered structure that includes a low-resistivity film (not shown) and a good-contact film (not shown), or the data lines 171, the drain electrodes 175, and the metal pieces 178 may have a single layered structure.

[0046] Similar to the gate lines 121 and the storage electrode lines 131, the data lines 171 and the drain electrodes 175 may have tapered lateral sides, and the inclination angles thereof may range from approximately 30 to 80 degrees.

[0047] The ohmic contact stripes 161 and ohmic contact islands 165 may only be interposed between the underlying

semiconductor stripes 151 and the overlying data lines 171 and the overlying drain electrodes 175 thereon and reduce the contact resistance therebetween. The semiconductor stripes 151 include a plurality of exposed portions, which are not covered with the data lines 171 and the drain electrodes 175, such as portions located between the source electrodes 173 and the drain electrodes 175. Although the semiconductor stripes 151 are mostly narrower than the data lines 171, the semiconductor stripes 151 widen near the gate lines 121 and the storage electrode lines 131 as described above, to smooth the profile of the surface, thereby preventing the disconnection of the data lines 171.

[0048] A passivation layer 180 is formed on the data lines 171, the drain electrodes 175, the metal pieces 178, and the exposed portions of the semiconductor stripes 151. The passivation layer 180 is may be made of an inorganic insulator material, such as silicon nitride or silicon oxide, a photosensitive organic material having a good flatness characteristic, or a low dielectric insulating material having a dielectric constant less than 4.0, such as a-Si:C:O and a-Si:O:F formed by plasma enhanced chemical vapor deposition (PECVD). The passivation layer 180 may have a double-layered structure that includes a lower inorganic film layer and an upper organic film layer.

[0049] The passivation layer 180 has a plurality of contact holes 182 and 185 exposing the end portions 179 of the data lines 171 and the end portions of the drain electrodes 175, respectively. The passivation layer 180 and the gate insulating layer 140 have a plurality of contact holes 181 exposing the end portions 129 of the gate lines 121, a plurality of contact holes 183a exposing portions of the storage electrode lines 131 near the fixed end portions of the first storage electrodes 133a and a plurality of contact holes 183b exposing the projections of the free end portions of the first storage electrodes 133a.

[0050] A plurality of pixel electrodes 190, a plurality of contact assistants 81 and 82, and a plurality of overpasses 83, which are may be made of a transparent conductor material, such as ITO or IZO, or a reflective conductor material, such as Ag or Al, are formed on the passivation layer 180.

[0051] The pixel electrodes 190 are physically connected with and coupled to the drain electrodes 175 through the contact holes 185 such that the pixel electrodes 190 receive data voltage from the drain electrodes 175.

[0052] The pixel electrodes 190 supplied with data voltage generates an electric field in cooperation with the common electrode 270, which determines the orientation of liquid crystal molecules 310 in the liquid crystal layer 3.

[0053] A pixel electrode 190 and the common electrode 270 form a liquid crystal capacitor, which stores applied voltages after the TFT is turned off. An additional capacitor, referred to as a "storage capacitor," is connected in parallel with the liquid crystal capacitor to increase the voltage storing capacity. The storage capacitors are implemented by overlapping the pixel electrodes 190 with the storage electrode lines 131 including the storage electrodes 133a-133d.

[0054] Each pixel electrode 190 is chamfered or beveled at its left corners and the chamfered edges of the pixel electrode 190 form approximately a 45 degree angle with the gate lines 121.

[0055] Each pixel electrode **190** has a lower cutout **92a**, a center cutout **91**, and an upper cutout **92b**, which partition the pixel electrode **190** into a plurality of partitions. The cutouts **91**, **92a**, and **92b** have a substantially inverted symmetry with respect to an imaginary transverse line bisecting the pixel electrode **190**.

[0056] The lower cutouts **92a** and the upper cutouts **92b** obliquely, or diagonally, extend from a right edge of the pixel electrode **190** near an upper right corner approximately to a center of a left edge of the pixel electrode **190** and overlap the third and the fourth storage electrodes **133c** and **133d**. The lower cutouts **92a** and the upper cutouts **92b** are disposed at lower and upper halves of the pixel electrode **190**, respectively, with respect to the imaginary transverse line dividing the pixel electrode **190**. The lower cutouts **92a** and the upper cutouts **92b** form approximately a 45 degree angle with the gate lines **121** and extend substantially perpendicular to each other.

[0057] The center cutout **91** extends along the imaginary transverse line dividing the pixel electrode **190** and has an inlet from the right edge of the pixel electrode **190**, which has a pair of inclined edges substantially parallel to the lower cutout **92a** and the upper cutout **92b**, respectively.

[0058] Accordingly, the lower half of the pixel electrode **190** is partitioned into two lower partitions by the lower cutout **92a** and the upper half of the pixel electrode **190** is also partitioned into two upper partitions by the upper cutout **92b**. It is understood that the number of partitions or the number of the cutouts varies depending on design factors, such as the size of pixels, the ratio of the transverse edges and the longitudinal edges of the pixel electrodes, the type and characteristics of the liquid crystal layer **3**, etc.

[0059] The contact assistants **81** and **82** are connected with the end portions **129** of the gate lines **121** and the end portions **179** of the data lines **171** through the contact holes **181** and **182**, respectively. The contact assistants **81** and **82** protect the end portions **129** and **179** and complement the adhesion of the end portions **129** and **179** and external devices.

[0060] The overpasses **183** cross over the gate lines **121** and they are connected with the exposed projection of the fixed end portions of the first storage electrodes **133a** and the exposed portions of the storage electrode lines **131** through the contact holes **183b** and **183a**, respectively, which are disposed opposite each other with respect to the gate lines **121**. The overpasses **183** overlaps the metal pieces **178** and they may be coupled to the metal pieces **178**. The storage electrode lines **131** including the storage electrodes **133a**, **133b**, **133c**, and **133d** along with the overpasses **183** and the metal pieces **178** are used to repair defects in the gate lines **121**, the data lines **171**, or the TFTs. The electrical connection between the gate lines **121** and the storage electrode lines **131** for repairing the gate lines **121** is obtained by illuminating the cross points of the gate lines **121** and the overpasses **83** by a laser beam to couple the gate lines **121** with the overpasses **83**. The metal pieces **178** enhance the electrical connection between the gate lines **121** and the overpasses **183**.

[0061] The description of the common electrode panel **200** follows with reference to FIG. 2, FIG. 3, and FIG. 4.

[0062] A plurality of color filters **230** are formed on the substrate **210** that substantially face the pixel electrode **190**

of the thin film transistor array panel. The color filters **230** may represent one of the primary colors, such as red, green, and blue. Each of the color filters **230** includes a plurality of depressions **232** and **234**, and the surface step due to the depressions **232** and **234**, and the adjacent color filters **230** are divided at predetermined distances to form a plurality of openings **231**. A portion of the surface of the substrate **210** is exposed through the openings **231**, and the exposed portion of the surface of the substrate **210** has a step for the surface of the color filters **230**.

[0063] A common electrode **270** may be made of a transparent conductive material, such as ITO and IZO, and is formed on the color filters **230**. The surface step formed on the common electrode **270** depends on the surface step of the color filters **230** and the step between the openings **231** and the surface of the color filters **230**.

[0064] A light blocking member **220**, referred to as a black matrix, prevents light leakage and a plurality of sets of protrusions **71**, **72a**, and **72b** are formed or provided on the common electrode **270**. The light blocking member **220** is located at or near the openings **231**. According to an embodiment of the invention, the light blocking member **220** is thicker than the color filters **230** in order to reduce optical density. When the light blocking member **220** is thin, such as, for example, thinner than the color filters **230**, the leakage light is generated through the light blocking member **220**.

[0065] The sets of protrusions **71**, **72a**, and **72b** are located at the depressions **232** and **234**, and have slope surfaces **281** and **282**.

[0066] A set of protrusions **71**, **72a**, and **72b** face a pixel electrode **190** and include a lower protrusion **72a**, a center protrusion **71**, and an upper protrusion **72b**. Each of the protrusion **71**, **72a**, and **72b** is disposed between adjacent cutouts **91**, **92a**, and **92b** of the pixel electrode **190** or between a cutout **92a** or **92b** and a chamfered edge of the pixel electrode **190**.

[0067] Further, each of the protrusions **71**, **72a**, and **72b** includes at least an oblique portion extending parallel to the lower cutout **92a** or the upper cutout **92b** of the pixel electrode **190**, and the distances between adjacent two of the protrusions **71**, **72a**, and **72b**, and **91**, **92a**, and **92b**, the oblique portions thereof, the oblique edges thereof, and the chamfered edges of the pixel electrode **190**, which are parallel to each other, are substantially the same. The protrusions **71**, **72a**, and **72b** have substantially an inversion symmetry with respect to the above-described transverse line bisecting the pixel electrode **190**.

[0068] Each of the lower and upper protrusions **72a** and **72b** includes an oblique portion extending approximately from a left edge of the pixel electrode **190** to approximately lower or upper edge of the pixel electrode **190**, and transverse and longitudinal portions extending from respective ends of the oblique portion along edges of the pixel electrode **190**, overlapping the edges of the pixel electrode **190**, and making obtuse angles with the oblique portion.

[0069] The center protrusion **71** includes a central transverse portion extending approximately from the left edge of the pixel electrode **190** along the third storage electrode **133c**, a pair of oblique portions extending from an end of the central transverse portion approximately to a right edge of

the pixel electrode and forms obtuse angles with the central transverse portion, and a pair of terminal longitudinal portions extending from the ends of the respective oblique portions along the right edge of the pixel electrode **190**, overlapping the right edge of the pixel electrode **190**, and forming obtuse angles with the respective oblique portions.

[0070] The number of the protrusions **71**, **72a**, and **72b** varies depending on design factors.

[0071] Alignment layers **11** and **21** that may be homotropic are coated on inner surfaces of the panels **100** and **200**, and polarizers **12** and **22** are provided on outer surfaces of the panels **100** and **200** such that their polarization axes may be crossed and one of the transmissive axes may be parallel to the gate lines **121**. One of the polarizers may be omitted when the LCD is a reflective LCD.

[0072] The LCD may further include at least one retardation film (not shown), e.g., phase compensating sheet or compensator, for compensating the retardation of the LC layer **3**. The retardation film has birefringence and gives a retardation opposite to that given by the LC layer **3**. The retardation film may include uniaxial or biaxial optical compensation film and may include a negative uniaxial compensation film.

[0073] The LCD may further include a backlight unit (not shown) supplying light to the LC layer **3** through the polarizers **12** and **22**, the retardation film, and the panels **100** and **200**.

[0074] The LC layer **3** may have negative dielectric anisotropy in a range of approximately 3 to 8 and the LC molecules **310** in the LC layer **3** may be vertically aligned such that their long axes are substantially vertical to the surfaces of the alignment layers **11** and **21** in the absence of an electric field. At this time, because the surfaces of the alignments **11** and **21** are parallel with the surfaces of the thin film transistor array panel **100** and the common electrode panel **200** in the greater part, the long axes of the LC molecules **310** in the LC layer **3** are vertically aligned to the surfaces of the thin film transistor array panel **100** and the common electrode panel **200**. However, the LC molecules **310** near the alignment layer **21** that are arranged on the slope surfaces **281** and **282** of the protrusions **71** and **72a** are pre-tilted near the slope surface of the alignment layer **21** depending on the slope angle of the slope surfaces **281** and **282** of the protrusions **71** and **72a**.

[0075] An electric field substantially perpendicular to the surfaces of the panels **100** and **200** is generated when applying the common voltage to the common electrode **270** and a data voltage to the pixel electrodes **190**. The LC molecules **310** may change orientation in response to the electric field such that the long axes of the LC molecules **310** are perpendicular to the field direction.

[0076] In the absence of the electric field, the LC molecules **310** are pre-tilted and the pre-tilt directions of the LC molecules **310** determine the tilt directions of the LC molecules **310** when the electric field is applied. Thus, for example, the tilt motion of the LC molecules **310** is rapidly tilted.

[0077] The depression of the common electrode **270** near the protrusions **71**, **72a**, and **72b** caused by the depressions **232** and **234** distorts the electric field to have a horizontal

component, and the horizontal component of the electric field is enforced when the dielectric constant of the depressions **71**, **72a**, and **72b** is lower than the LC layer **3**. Accordingly, the LC molecules **310** located near the protrusions **71** and **72a** are first tilted by the horizontal component, and such tilt determines the tilt directions of the LC molecules **310** located far from the protrusions **71**, **72a**, and **72b** and reduces the response time of the LC molecules **310**.

[0078] The cutouts **91**, **92a**, and **92b** of the pixel electrodes **190** and the oblique edges of the pixel electrodes **190** distort the electric field so that the electric fields have a horizontal component.

[0079] The pre-tilted direction caused by the protrusions **71**, **72a**, and **72b**, the horizontal component of the electric field caused by the depressions **232** and **234**, the cutouts **91**, **92a**, and **92b** of the electrodes **190**, and the edges of the pixel electrodes **190**, distort the electric field to have a charge that is substantially perpendicular to the edges of the cutouts **91**, **92a**, and **92b** and the protrusions **71**, **72a**, and **72b** and the edges of the pixel electrodes **190**. Accordingly, the LC molecules on each sub-area tilt in a direction by the horizontal component and the azimuthal distribution of the tilt directions are localized to four directions, thereby increasing the viewing angle of the LCD. The regions of the LC layer **3** having the same tilt direction is referred to as domain, and the cutouts **91**, **92a**, and **92b** and the protrusions **71**, **72a**, and **72b** are referred to as the boundary of the domain.

[0080] The side of the storage electrodes **133c** and **133d** near the cutouts **91**, **92a**, and **92b** of the pixel electrode **190** extend along with the cutouts **91**, **92a**, and **92b** of the pixel electrode **190**, and the fringe field caused by the cutouts **91**, **92a**, and **92b** is enforced. Accordingly, the response time for tilting the LC molecules and the texture is improved.

[0081] A method of manufacturing a common electrode panel of the LCD shown in FIG. 1, FIG. 2, FIG. 3, FIG. 4, and FIG. 5 according to an embodiment of the invention is described in detail with reference to FIG. 6A and FIG. 6B. FIG. 6A and FIG. 6B are sectional views of a common electrode panel shown in FIG. 2, FIG. 3, and FIG. 4 taken along the line IV-IV'.

[0082] Referring to FIG. 6A, a negative photosensitive organic material having red pigments is coated on an insulating substrate **210** to a color filter **230** and a photo-mask **40** is aligned on the substrate **210**. The photo-mask **40** has a transparent film **41** and an opaque film **42** formed on the transparent film **41**, and includes an opaque area where the opaque film **42** is wider than a predetermined or fixed value, a transmissive area where the opaque film **42** is not formed, and a translucent area of a slit type where the width and the interval of the opaque film **42** is less than a predetermined or fixed value. Portions of the color filter **230** facing the transmissive areas absorb the full energy of the light, while portions of the color filter **230** facing the translucent area partially absorb the light energy. Accordingly, the color filter **230** is developed, and the thickness of the portions of the color filter **230** facing the transmissive area is unchanged, e.g., full thickness, the portions facing the translucent areas have a reduced thickness to form a plurality of depressions **232** and **234**, and the portion of the color filter **230** facing the opaque area is removed. The hatched portions of the color filter **230** in FIG. 6A are portions of the color filter to be removed after developing.

[0083] After forming a red color filter **230** with the above-described method, negative photosensitive organic materials respectively including green and blue pigments are sequentially coated and developed on the insulating substrate **210** to form green and blue color filters **230**, respectively. At this time, the color filters **230** for red, blue and green colors are formed at regular intervals to form a plurality of openings **231**.

[0084] Referring to FIG. 6b, an ITO or IZO layer is subsequently deposited on the color filter **230** to form a common electrode **270**. Portions of the common electrode **270** may be depressed due to the depressions **232** and **234** of the color filters **230**. The depressed portion of the common electrode **270** generate fringe fields. In this manufacturing method, patterning the common electrode **270** is omitted through the photolithography process, and the fringe field to form a plurality of domains may effectively be generated. Accordingly, the manufacturing methods may be simplified, and ITO etchant may prevent the color filters from damaging.

[0085] A positive photosensitive organic material containing black pigments is subsequently coated, and an exposure-mask **50** is aligned on the insulating substrate **210**. The photo-mask **50** has a transparent film **51** and an opaque film **52** formed on the transparent film **51**, and includes an opaque area where the opaque film **52** is wider than a predetermined or fixed value, a transmissive area where the opaque film **42** is not formed, and a translucent area of a slit type where the width and the interval of the opaque film **42** is less than a predetermined or fixed value.

[0086] At this time, the opaque area and the translucent area are respectively aligned at the depressions **232** and **234** of the color filters **230**. Accordingly, the organic layer is exposed through the photo-mask **50** and forms a blocking light member **220** and a plurality of protrusions **71** and **72a**. The thickness of the organic layer and the intervals of slits are determined according to the height of center portions of the protrusions **71** and **72a**, the slope angle of the surface of the protrusions **71** and **72a**, and the blocking light member **220**. According to an embodiment of the invention, the intervals and the widths of slits are determined such that the thicknesses of the blocking light member **220** is the same as the thickness of the color filters **230**.

[0087] A method of manufacturing the TFT array panel shown in FIG. 1, FIG. 2, FIG. 3, FIG. 4, and FIG. 5 according to an embodiment of the invention is described below in detail with reference to FIG. 7A, FIG. 7B, FIG. 8A, and FIG. 8B. FIG. 7A and FIG. 7B are sectional views of the TFT array panel shown in FIG. 1 and FIG. 3, FIG. 4, and FIG. 5. FIG. 8A and FIG. 8B are sectional views of the TFT array panel, respectively, showing the TFT array panel after the TFT array panel shown in FIG. 7A and FIG. 7B has subsequently undergone another manufacturing method.

[0088] Referring to FIG. 1, FIG. 7A and FIG. 7B, a conductive layer of metal such as Al, is Al alloy, Ag, Ag alloy, Cr, Mo, Mo alloy, Ti or Ta is sputtered on an insulating substrate **110** and the substrate is wet or dry etched in sequence to form a plurality of gate lines **121** including gate electrodes **124** and end portions **129**, a plurality of storage electrode lines **131** including storage electrodes **133a-133d**, and a connection **133e** (the first mask). The gate lines **121**

and the storage electrode lines **131** may have a double layered structure that includes two films having different physical characteristics. One of the two films may be made of a low resistivity metal material including Al containing metal, Ag containing metal, and Cu containing metal to reduce signal delay or voltage drop in the gate lines **121** and the storage electrode lines **131**. The other film is may be made of a material such as Mo containing metal, Cr, Ta or Ti, which has good physical, chemical, and electrical contact characteristics with other materials.

[0089] After the gate insulating layer **140** is formed by a sequential deposition process such that the thickness of the gate insulating layer varies between approximately 1,500 to 5,000 Å, an intrinsic a-Si layer with thickness of between approximately 500 to 2,000 Å, and an extrinsic a-Si layer with thickness of between approximately 300 to 600 Å, wherein the extrinsic a-Si layer and the intrinsic a-Si layer are photo-etched to form a plurality of extrinsic semiconductor stripes and a plurality of intrinsic semiconductor stripes **151** including projections **154** on the gate insulating layer **140** (the second mask).

[0090] A conductive film having a thickness of between approximately 1,500 to 3,000 Å is subsequently sequentially sputtered and patterned to form a plurality of data lines **171** including source electrodes **173** and end portions **179**, and a plurality of drain electrodes **175**. The conductive film may be made of Cr, Mo, Mo alloy, Al, Al alloy, Ag, Ag alloy (the third mask). The conductive film may also be formed to have a double layered structure that includes two films having different physical characteristics. One of the two films may be made of a low resistivity metal material including Al containing metal, Ag containing metal, and Cu containing metal for reducing signal delay or voltage drop in the gate lines **121** and the storage electrode lines **131**. The other film may be made of a material such as Mo containing metal, Cr, Ta or Ti, which has good physical, chemical, and electrical contact characteristics with other materials.

[0091] Portions of the extrinsic semiconductor stripes, which are not covered with the data lines **171** and the drain electrodes **175**, are subsequently removed to complete a plurality of ohmic contact stripes **161** including projections **163** and a plurality of ohmic contact islands **165** and to expose portions of the intrinsic semiconductor stripes **151**. Oxygen plasma treatment may be subsequently performed to stabilize the exposed surfaces of the semiconductor stripes **151**.

[0092] Referring to FIG. 8A and FIG. 8B, a passivation layer **180** made of a photosensitive organic insulator is coated and exposed through a photo-mask **60** having a plurality of opaque film **62**, a transparent film **61**, and slit parts (the fourth mask). The passivation layer **180** is subsequently developed to form a plurality of contact holes **182** and **185** exposing portions of the end portions **179** of the data lines **171** and portions of the drain electrodes **175**, respectively, and to form a plurality of contact holes **181** exposing the end portions **129** of the gate lines **121**. At this time, the slit parts are aligned to the sidewalls of the contact holes **181**, **182** and **185** to form the sidewalls of the contact holes **181**, **182** and **185** having stepped or slope profiles.

[0093] Next, a plurality of pixel electrodes **190** and a plurality of contact assistants **81** and **82** are formed on the passivation layer **180** by sputtering and photo-etching an

IZO or ITO layer with thickness of between approximately 400 to 500 Å, as shown in **FIG. 4** and **FIG. 5** (the fifth mask).

[0094] Five photo-masks are used in the above-described manufacturing method, however the invention is not limited to the above described five photo-masks. For example, according to another embodiment on the invention, only four photo-masks may be used to complete a thin film transistor array panel.

[0095] In above-described embodiments of the LCD, although the photolithography of the common electrode **270** of the common electrode panel **200** is omitted, the fringe field effect may be provided by making the depressions of the common electrode **270** corresponding to the depressions **232** and **234** of the color filters **230**. Therefore, the problems generated by patterning the common electrode **270**, such as damage of color filters and formation of an overcoat covering the common electrode, may be removed.

[0096] Additionally, the protrusions formed in the photolithography process forming the blocking light member are used to divide the color filter into multi-domains and to control the domains, and the process of forming a protrusion may be omitted, which simplifies the manufacturing method of the LCD.

[0097] Further, the LCD of vertical aligned (VA) type including the protrusions may reduce the response time of LC molecules. The response characteristics of the LCD may be improved by rapidly and partially controlling response time of VA type LCD. Also, the simplified manufacturing process of the LCD reduces manufacturing costs.

[0098] It will be apparent to those skilled in the art that various modifications and variation can be made in the present invention without departing from the spirit or scope of the invention. Thus, it is intended that the present invention cover the modifications and variations of this invention provided they come within the scope of the appended claims and their equivalents.

What is claimed is:

1. A liquid crystal display, comprising:

a substrate;

a color filter having a depression and an opening and formed on the substrate;

a common electrode having a depression and formed on the color filter; and

a light blocking member formed on the common electrode and located at the depression of the common electrode.

2. The liquid crystal display of claim 1, wherein the depression of the common electrode is formed by the depression and the opening of the color filter.

3. The liquid crystal display of claim 2, wherein the light blocking member has a protrusion overlapping the depression of the color filter and protruded to an upside of the color filter.

4. The liquid crystal display panel of claim 3, wherein the protrusion has a sloped surface.

5. The liquid crystal display of claim 2, wherein the light blocking member includes a portion that overlaps the opening of the color filter and has substantially a same height as a height of the color filter.

6. The liquid crystal display of claim 1, wherein the light blocking member comprises an organic material.

7. A liquid crystal display, comprising:

a first substrate;

a plurality of pixel electrodes, provided on the first substrate, including an opening;

a second substrate facing the first substrate;

a color filter, provided on the second substrate, having a depression facing the pixel electrodes and an opening facing the region between the pixel electrodes;

a common electrode, provided on the color filter, having a depression formed by the depression and the opening of the color filter; and

a light blocking member provided on the common electrode and located at the depression of the common electrode.

8. The liquid crystal display of claim 7, wherein the light blocking member has a protrusion overlapping the depression of the color filter and protruded to an upside of the color filter.

9. The liquid crystal display panel of claim 8, wherein the protrusion has a sloped surface.

10. The liquid crystal display of claim 7, wherein the light blocking member includes a portion overlapping the opening of the color filter and has substantially a same height as a height of the color filter.

11. The liquid crystal display of claim 7, further comprising:

a liquid crystal layer formed between the first and the second substrates, and having negative dielectric anisotropy.

12. The liquid crystal display of claim 11, wherein negative dielectric anisotropy of the liquid crystal layer is in a range of approximately 3 to 8.

13. The liquid crystal display of claim 12, wherein the light blocking member comprises an organic insulator having a dielectric constant that is less than or equal to the liquid crystal layer.

14. A method for manufacturing a liquid crystal display panel, comprising:

forming a color filter having a depression and an opening;

forming a common electrode on the color filter; and

forming a light blocking member on the common electrode,

wherein, the light blocking member is formed by a photolithography process using a photo-mask having an opaque area facing the depression of the color filter, a translucent area facing the opening of the color filter, and a transmissive area facing a portion of the color filter that does not include the depression or the opening.

15. The method of **14**, further comprising:

forming the color filter by a photolithography process using a photo-mask having an opaque portion facing the opening of the color filter, a translucent portion facing the depression of the color filter, and a transmissive area facing a portion of the color filter that does not include the depression or the opening.

16. The method of **14**, wherein the light blocking member has a protrusion overlapping the depression of the color filter and protruded to the upside of the color filter.

17. The liquid crystal display panel of claim 16, wherein the protrusion has a sloped surface.

18. A liquid crystal display, comprising:

a substrate;

a color filter, provided on the substrate, having a depression and an opening;

a common electrode, provided on the color filter, having a depression formed by the depression and the opening of the color filter; and

a black matrix formed on the common electrode.

19. The liquid crystal display of claim 18, wherein the black matrix is located at the depression and the opening of the color filter.

* * * * *

专利名称(译)	液晶显示器及其制造方法		
公开(公告)号	US20050264722A1	公开(公告)日	2005-12-01
申请号	US11/134268	申请日	2005-05-23
[标]申请(专利权)人(译)	CHOI NAK CHO		
申请(专利权)人(译)	崔NAK-CHO		
当前申请(专利权)人(译)	三星DISPLAY CO. , LTD.		
[标]发明人	CHOI NAK CHO		
发明人	CHOI, NAK-CHO		
IPC分类号	G02F1/1343 G02F1/1333 G02F1/1335 G02F1/139		
CPC分类号	G02F1/133514 G02F1/1393 G02F1/133707		
优先权	1020040036784 2004-05-24 KR		
其他公开文献	US7453536		
外部链接	Espacenet USPTO		

摘要(译)

提供一种液晶显示器，包括：基板；滤色器，形成在基板上，具有凹陷和开口；形成在滤色器上的公共电极，具有凹陷；黑色部件形成在公共电极上并位于公共电极的凹陷处。

